

N-Channel MOSFET MEM2310M3

General Description

MEM2310M3G Series N-channel enhancement mode field-effect transistor ,produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications, and low power dissipation in a very small outline surface mount package.

Features

• 30V/5.8A

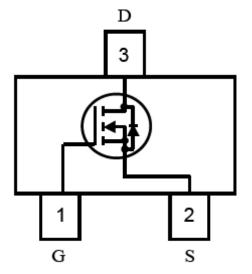
 $R_{DS(ON)}$ =25m Ω @ V_{GS}=10V, I_D=5.8A

 $R_{DS(ON)}$ =28m Ω V_{GS}=4.5V, I_D=5A

 $R_{DS(ON)}$ =37m Ω @ V_{GS}=2.5V, I_D=4A

- High Density Cell Design For Ultra Low On-Resistance
- Subminiature surface mount package:SOT23-3L

Pin Configuration



Absolute Maximum Ratings

Typical Application

- Battery management
- High speed switch
- Low power DC to DC converter

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		V _{DSS}	30V	V
Gate-Source Voltage		V _{GSS}	±12	V
Drain	T _A =25℃	1	5.8	٨
Current	T _A =70℃	I _D	4.9	A
Pulsed Drain Current ^{1,2}		I _{DM}	30	A
Total Power	T _A =25℃	Pd	1.4	- W
Dissipation	T _A =70℃	Fu	1	VV
operating junction temperature		Tj	150	°C
Storage Temperature Range		T _{stg}	-65/150	°C



Thermal Characteristics

Parameter	Symbol	TYP.	MAX.	Unit	
Thermal Resistance, Junction-to-Ambient	t≤10s	RθJA	65	90	°C/W
Thermal Resistance, Junction-to-Ambient Steady-State		RθJA	85	125	°C/W
Thermal Resistance, Junction-to-Lead	Steady-State	RθJL	43	60	°C/W

Electrical Characteristics

MEM2310M3

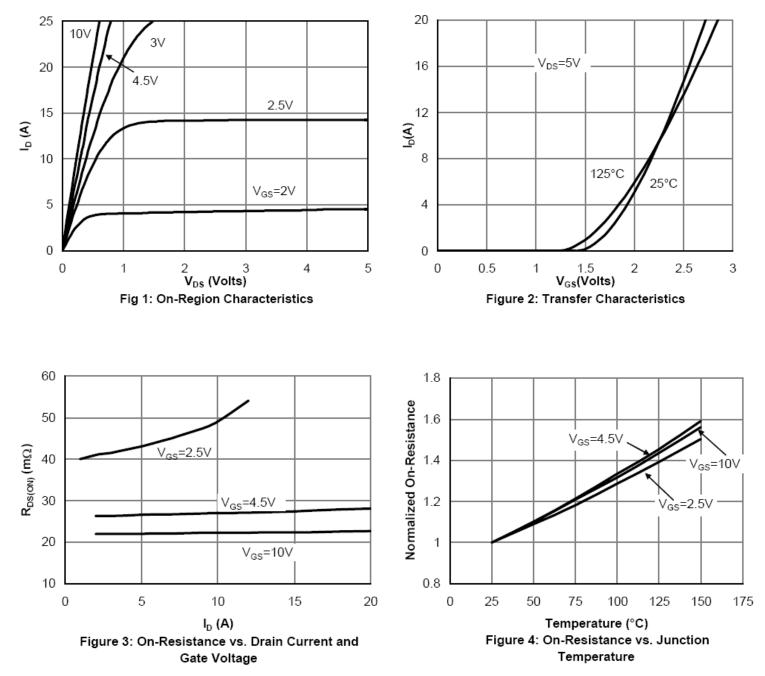
Parameter	Symbol	Test Condition	Min	Туре	Max	Unit			
Static Characteristics									
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V _{GS} =0V, I _D =250uA	30	35		V			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250$ uA	0.7	0.88	1.4	V			
Gate-Body Leakage		$V_{DS}=0V$, $V_{GS}=12V$		0.5	100	nA			
Gale-Douy Leakage	I _{GSS}	V_{DS} =0V, V_{GS} =-12V		-0.2	-100	nA			
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =24V V_{GS} =0V			1000	nA			
	R _{DS(ON)}	V _{GS} =10V, I _D =5.8A		25	30	mΩ			
Static Drain-Source On-Resistance		V_{GS} =4.5V, I_{D} =5A		28	33	mΩ			
		V _{GS} =2.5V, I _D =4A		37	50	mΩ			
Forward Transconductance	g fs	$V_{DS} = 5 V, I_{D} = 5A$	10	15		S			
Maximum Body-Diode Continuous Current	ls				2.5	A			
Source-drain (diode forward) voltage	V_{SD}	V _{GS} =0V,I _S =1A		0.72	1.0	V			
Dynamic Characteristics									
Input Capacitance	Ciss	$V_{DS} = 15 V,$		823	1030				
Output Capacitance	Coss	$V_{GS} = 0 V,$		99		pF			
Reverse Transfer Capacitance	Crss	f = 1 MHz		77					
Gate resistance	Rg	V _{GS} =0V, V _{DS} =0V, f=1MHz		1.2	3.6	Ω			
Switching Characteristics									
Turn-On Delay Time	td(on)	V _{DD} = 15 V,		7	14				
Rise Time	tr	$R_L = 2.7\Omega$		15	30	ns			
Turn-Off Delay Time	td(off)	$V_{GEN} = 10V,$ Rg = 3 Ω		38	76				
Fall-Time	tf	ry - 3 12		3	6				
Total Gate Charge	Qg	V _{DS} = 15 V,		11	14.3				
Gate-Source Charge	Qgs	$V_{GS} = 4.5 V,$		1.6	2.08	nc			
Gate-Drain Charge	Qgd	$I_D = 5.8A$		2.8	3.64				

1. Repetitive rating, pulse width limited by junction temperature.

 $2 \$ Pulse width <300us , duty cycle <0.5%.

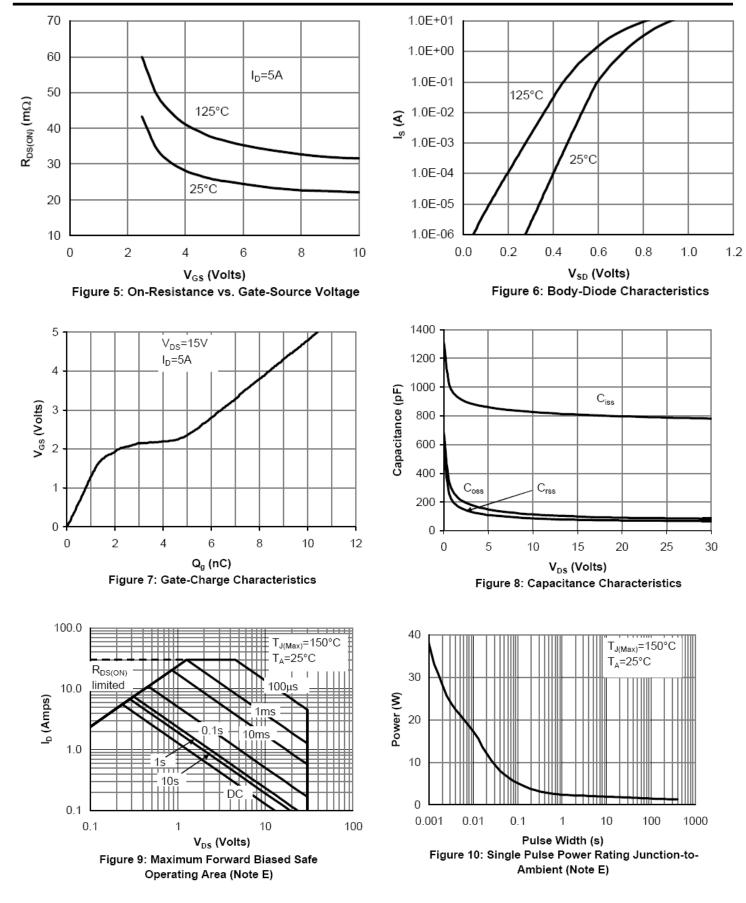


Typical Performance Characteristics





MEM2310





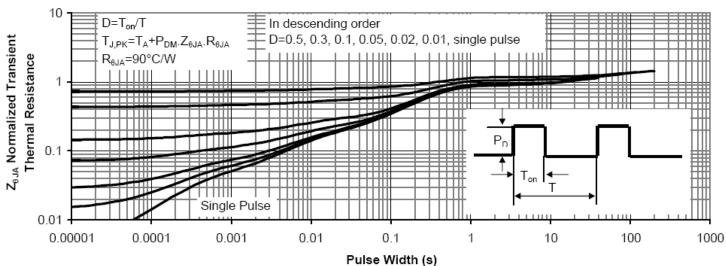
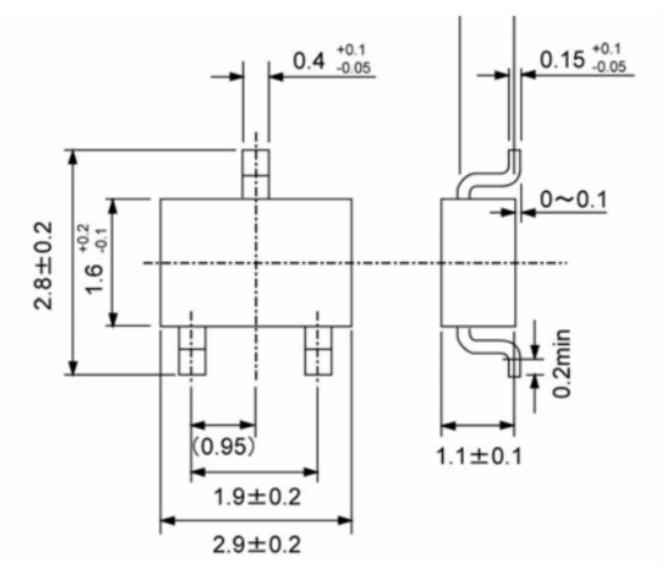


Figure 11: Normalized Maximum Transient Thermal Impedance



Package Information





- The information described herein is subject to change without notice.
- Nanjing Micro One Electronics Inc is not responsible for any problems caused by circuits or diagrams described herein whose related industrial properties, patents, or other rights belong to third parties. The application circuit examples explain typical applications of the products, and do not guarantee the success of any specific mass-production design.
- Use of the information described herein for other purposes and/or reproduction or copying without the express permission of Nanjing Micro One Electronics Inc is strictly prohibited.
- The products described herein cannot be used as part of any device or equipment affecting the human body, such as exercise equipment, medical equipment, security systems, gas equipment, or any apparatus installed in airplanes and other vehicles, without prior written permission of Nanjing Micro One Electronics Inc.
- Although Nanjing Micro One Electronics Inc exerts the greatest possible effort to ensure high quality and reliability, the failure or malfunction of semiconductor products may occur. The user of these products should therefore give thorough consideration to safety design, including redundancy, fire-prevention measures, and malfunction prevention, to prevent any accidents, fires, or community damage that may ensue.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Micro One manufacturer:

Other Similar products are found below :

614233C 648584F MCH3443-TL-E MCH6422-TL-E FDPF9N50NZ FW216A-TL-2W FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E FCA20N60_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T) D2294UK 405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G 614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3